



- 1 WHEN MATING THE CONNECTOR, PLEASE HOLD MILLING AREA OF  $6.4 \pm 0.2 \text{ [mm]}$  WITH A SPANNER NOT TO PLACE STRESS ON PCB BY THE TORQUE.
- 2 0-80UNF-2B SCREW TIGHTENING TORQUE IS  $0.09 \text{ N} \cdot \text{m}$ . PLEASE TIGHTEN THE SCREWS EVENLY WHEN MOUNTING THE CONNECTORS TO ENSURE STABLE ELECTRICAL CONTACT.
- 3 PLEASE USE A PCB MOUNTING SCREW OF THE LENGTH OF  $L \text{ [mm/in]}$ . THE LENGTH OF  $L \text{ [mm/in]}$  IS PCB THICKNESS  $t_1$  + SPRING WASHER THICKNESS  $t_2$  +  $1.8 \text{ mm}/0.07 \text{ in}$ . PLEASE USE A SCREW WITH SPRING WASHER.
- 4 THE INDICATED DIMENSION IS THE CASE OF WHICH DIELECTRIC CONSTANT OF SUBSTRATE IS 3.6 AND THICKNESS IS  $t = 0.2 \text{ mm}/0.008 \text{ in}$ . LAND PATTERN LAYOUT DEPENDS ALSO ON ELECTRIC CONSTANT, THICKNESS AND LAYER CONSTRUCTION OF PCB. FOR BETTER RF PERFORMANCE, SIMULATION OF PCB WITH CONNECTOR IS RECOMMENDED.
- 5 RECOMMENDED PCB THICKNESS  $t_1$  IS GREATER THAN  $1.0 \text{ mm}/0.04 \text{ in}$ .
- 6 SIDE PLATING OF THE BOARD IS RECOMMENDED.
- 1 7. THIS PRODUCT IS A SOLDERLESS MOUNTED CONNECTOR FOR PROTOTYPE EVALUATION OF HIGH SPEED TRANSMISSION BOARDS. IT IS NOT RECOMMENDED FOR USE IN ACTUAL COMMERCIAL EQUIPMENT.

( 1 ) WHEN THE CONNECTOR IS MOUNTED ON PCB, PLEASE DO NOT ALLOW A GAP BETWEEN THE EDGE OF PCB AND CONNECTOR.  
( 2 ) PLEASE MOUNT THE CONNECTOR AS LOCATED IN THE MIDDLE OF THE SIGNAL PAD OF PCB.



Figure 1 is a dimensional drawing of a microstrip line on a PCB. The drawing includes a top view and a cross-section B(10:1).

**Top View Dimensions:**

- SIGNAL PAD:** Width is  $8.5 \pm 0.35$  MIN. The distance from the center of the through hole to the edge of the signal pad is  $5 \pm 0.03$  or  $.197 \pm .001$ .
- GROUND PAD:** Width is  $4.3 \pm 0.169$  MIN. The distance from the center of the through hole to the edge of the ground pad is  $0.35 \pm 0.014$ .
- SIGNAL LINE:** Width is  $0.35 \pm 0.014$ .
- THROUGH HOLE:** Diameter is  $2 \times \phi 1.7 \pm 0.05$  or  $.067 \pm .002$ .
- EDGE OF PCB:** Indicated by a dimension line and a note.
- Other Dimensions:** The distance from the top edge of the signal pad to the center of the through hole is  $2.2 \pm 0.05$  or  $.087 \pm .002$ . The distance from the bottom edge of the ground pad to the center of the through hole is  $4.3 \pm 0.169$  MIN.

**Cross-section B(10:1) Dimensions:**

- Core Thickness:**  $0.75 \pm 0.03$  or  $.030 \pm .001$ .
- Prepreg Thickness:**  $0.28 \pm 0.011$ .
- Microstrip Line Thickness:**  $0.35 \pm 0.014$ .
- Through Hole Diameter:**  $1.7 \pm 0.05$  or  $.067 \pm .002$ .
- Other Dimensions:** The distance from the top edge of the core to the center of the through hole is  $0.7 \pm 0.028$ .

REGISTER FOR SIGNAL PAD AND GROUND PAD IS PROHIBITED.



**HIROSE  
ELECTRIC  
CO., LTD.**